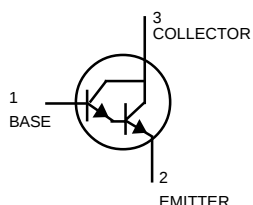
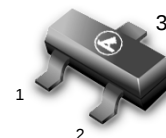


Darlington Amplifier Transistors

NPN Silicon



MMBTA13LT1
MMBTA14LT1



CASE 318-08, STYLE 6
SOT-23 (TO-236AB)

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V_{CES}	30	Vdc
Collector-Base Voltage	V_{CBO}	30	Vdc
Emitter-Base Voltage	V_{EBO}	10	Vdc
Collector Current — Continuous	I_C	300	mAdc

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board, (1) $T_A = 25^\circ\text{C}$	P_D	225	mW
Derate above 25°C		1.8	mW/ $^\circ\text{C}$
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	556	$^\circ\text{C/W}$
Total Device Dissipation Alumina Substrate, (2) $T_A = 25^\circ\text{C}$	P_D	300	mW
Derate above 25°C		2.4	mW/ $^\circ\text{C}$
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	417	$^\circ\text{C/W}$
Junction and Storage Temperature	T_J, T_{stg}	-55 to +150	$^\circ\text{C}$

DEVICE MARKING

MMBTA13LT1 = 1M; MMBTA14LT1 = 1N

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
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OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage ($I_C = 100 \mu\text{Adc}$, $V_{BE} = 0$)	$V_{(BR)CEO}$	30	—	Vdc
Collector Cutoff Current ($V_{CB} = 30\text{Vdc}$, $I_E = 0$)	I_{CBO}	—	100	nAdc
Emitter Cutoff Current ($V_{EB} = 10\text{Vdc}$, $I_C = 0$)	I_{EBO}	—	100	nAdc

1. FR-5 = $1.0 \times 0.75 \times 0.062$ in.

2. Alumina = $0.4 \times 0.3 \times 0.024$ in. 99.5% alumina.

MMBTA13LT1 MMBTA14LT1

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted) (Continued)

Characteristic	Symbol	Min	Max	Unit
ON CHARACTERISTICS (3)				
DC Current Gain ($I_C = 10\text{ mAdc}$, $V_{CE} = 5.0\text{ Vdc}$)	h_{FE}	5,000	—	—
MMBTA14		10,000	—	—
($I_C = 100\text{ mAdc}$, $V_{CE} = 5.0\text{ Vdc}$)		10,000	—	—
MMBTA14		20,000	—	—
Collector–Emitter Saturation Voltage ($I_C = 100\text{ mAdc}$, $I_B = 0.1\text{ mAdc}$)	$V_{CE(sat)}$	—	1.5	Vdc
Base–Emitter On Voltage ($I_C = 100\text{ mAdc}$, $V_{CE} = 5.0\text{ Vdc}$)	V_{BE}	—	2.0	Vdc

SMALL–SIGNAL CHARACTERISTICS

Current – Gain–Bandwidth Product(4) ($V_{CE} = 5.0\text{ Vdc}$, $I_C = 10\text{ mAdc}$, $f = 100\text{ MHz}$)	f_T	125	—	MHz
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3. Pulse Test: Pulse Width $\leq 300\text{ }\mu\text{s}$, Duty Cycle $\leq 2.0\%$.

4. $f_T = |h_{fe}| * f_{test}$.

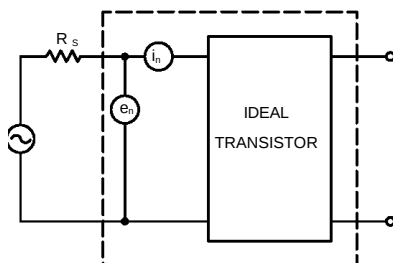


Figure 1. Transistor Noise Model

MMBTA13LT1 MMBTA14LT1

NOISE CHARACTERISTICS

($V_{CE} = 5.0 \text{ Vdc}$, $T_A = 25^\circ\text{C}$)

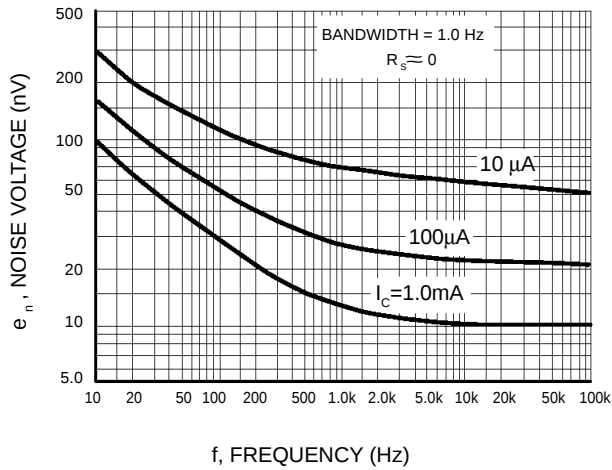


Figure 2. Noise Voltage

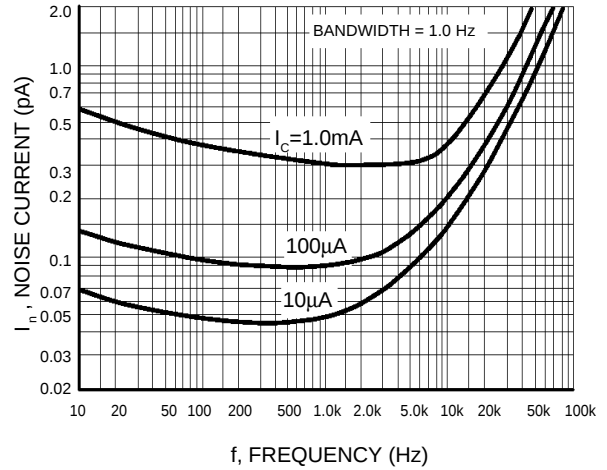


Figure 3. Noise Current

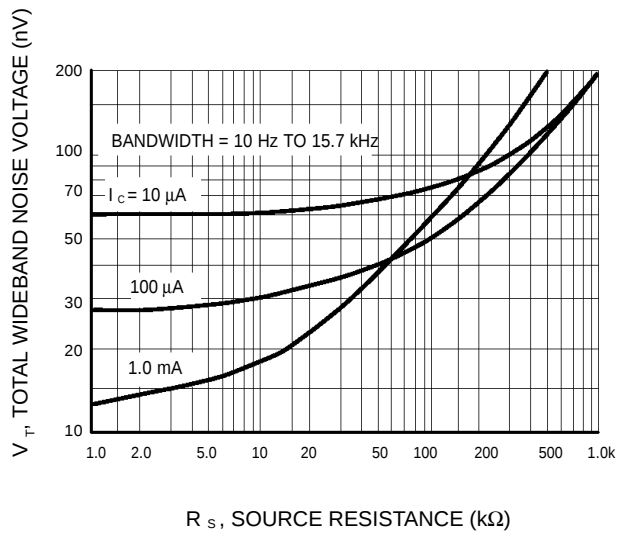


Figure 4. Total Wideband Noise Voltage

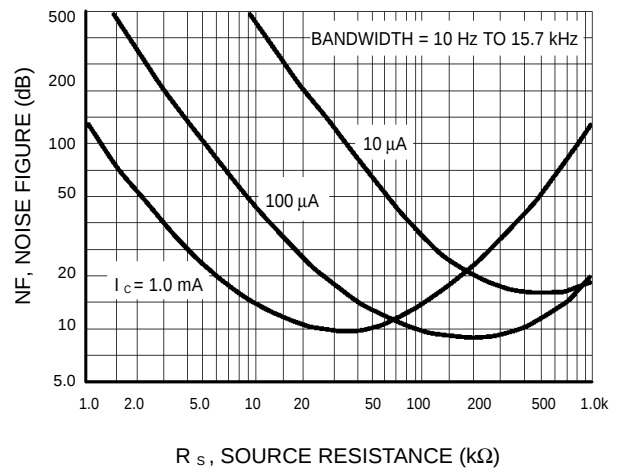
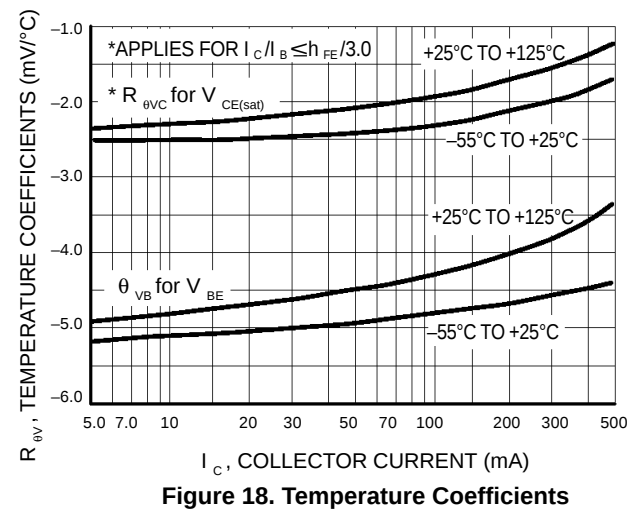
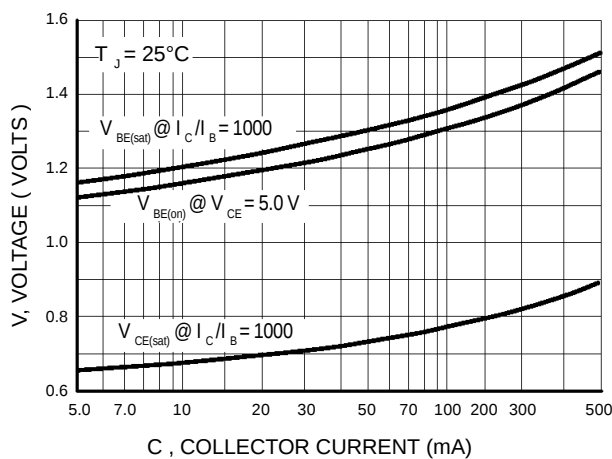
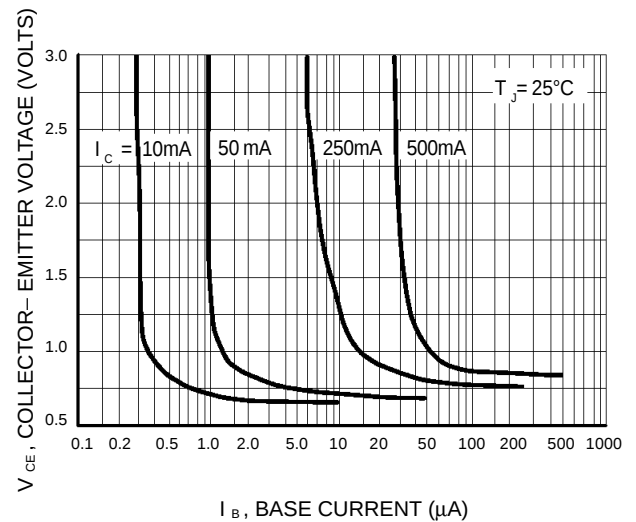
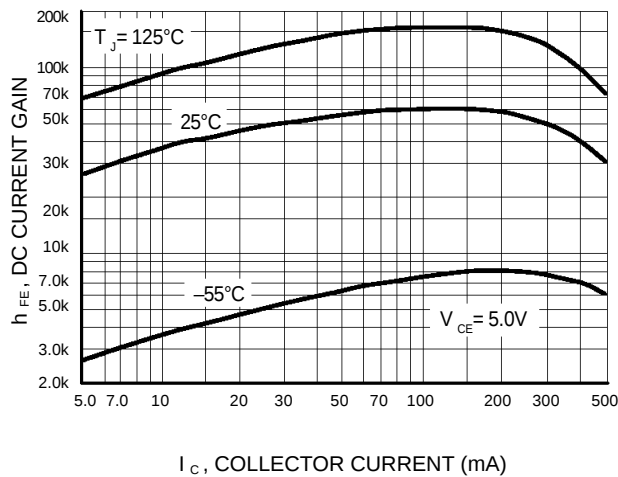
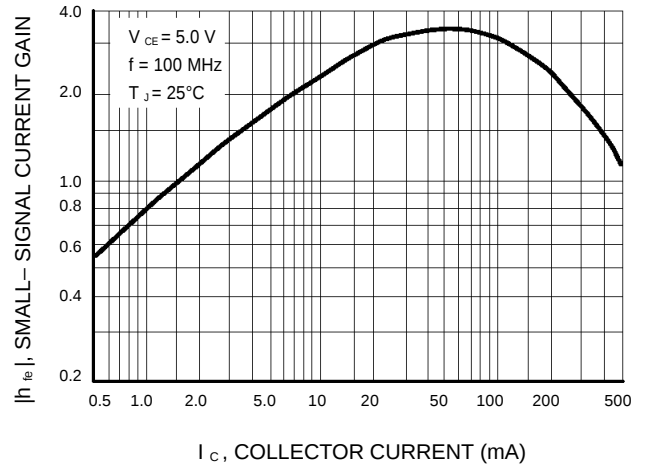
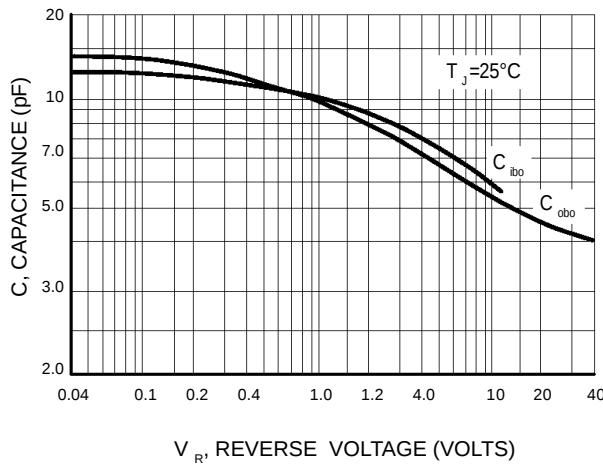


Figure 5. Wideband Noise Figure

MMBTA13LT1 MMBTA14LT1

SMALL-SIGNAL CHARACTERISTICS



MMBTA13LT1 MMBTA14LT1

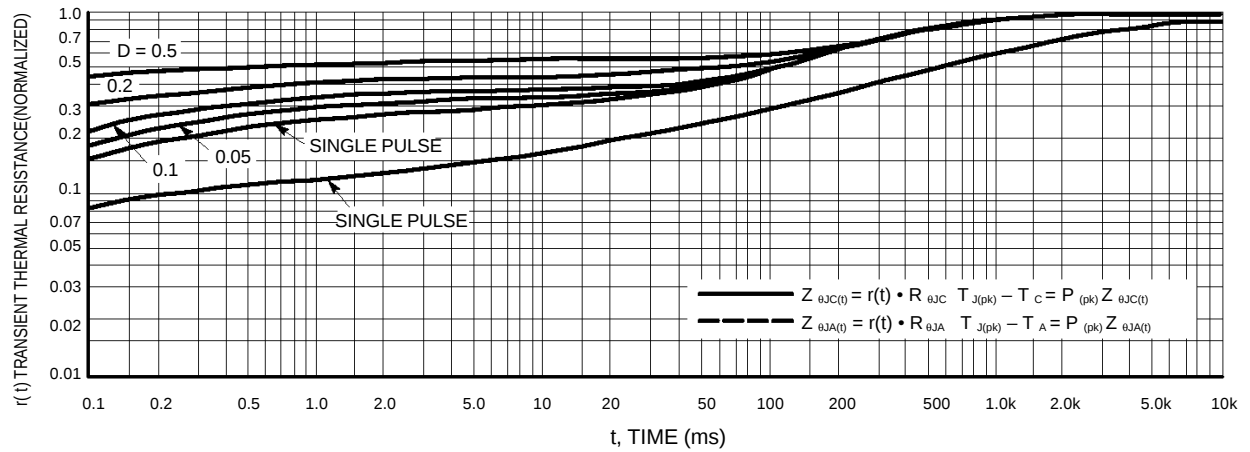


Figure 12. Thermal Response

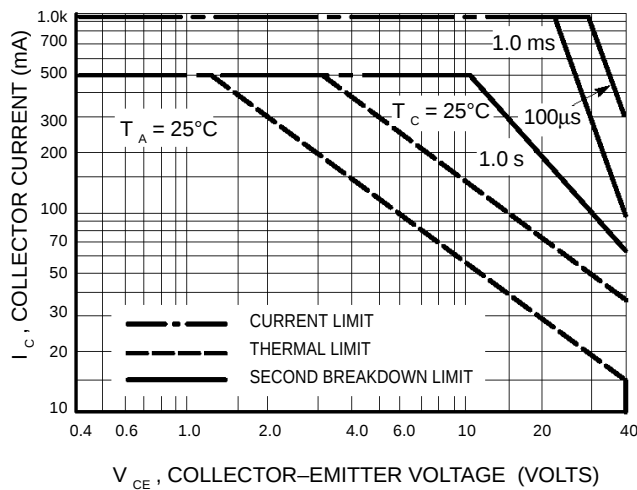
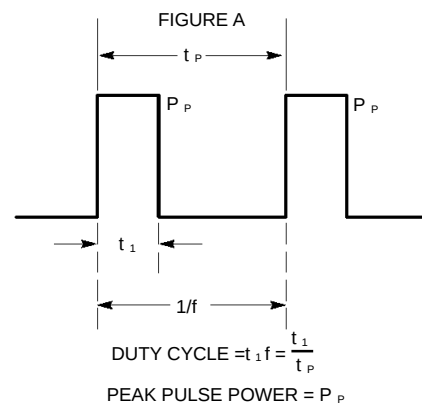


Figure 13. Active Region Safe Operating Area



Design Note: Use of Transient Thermal Resistance Data